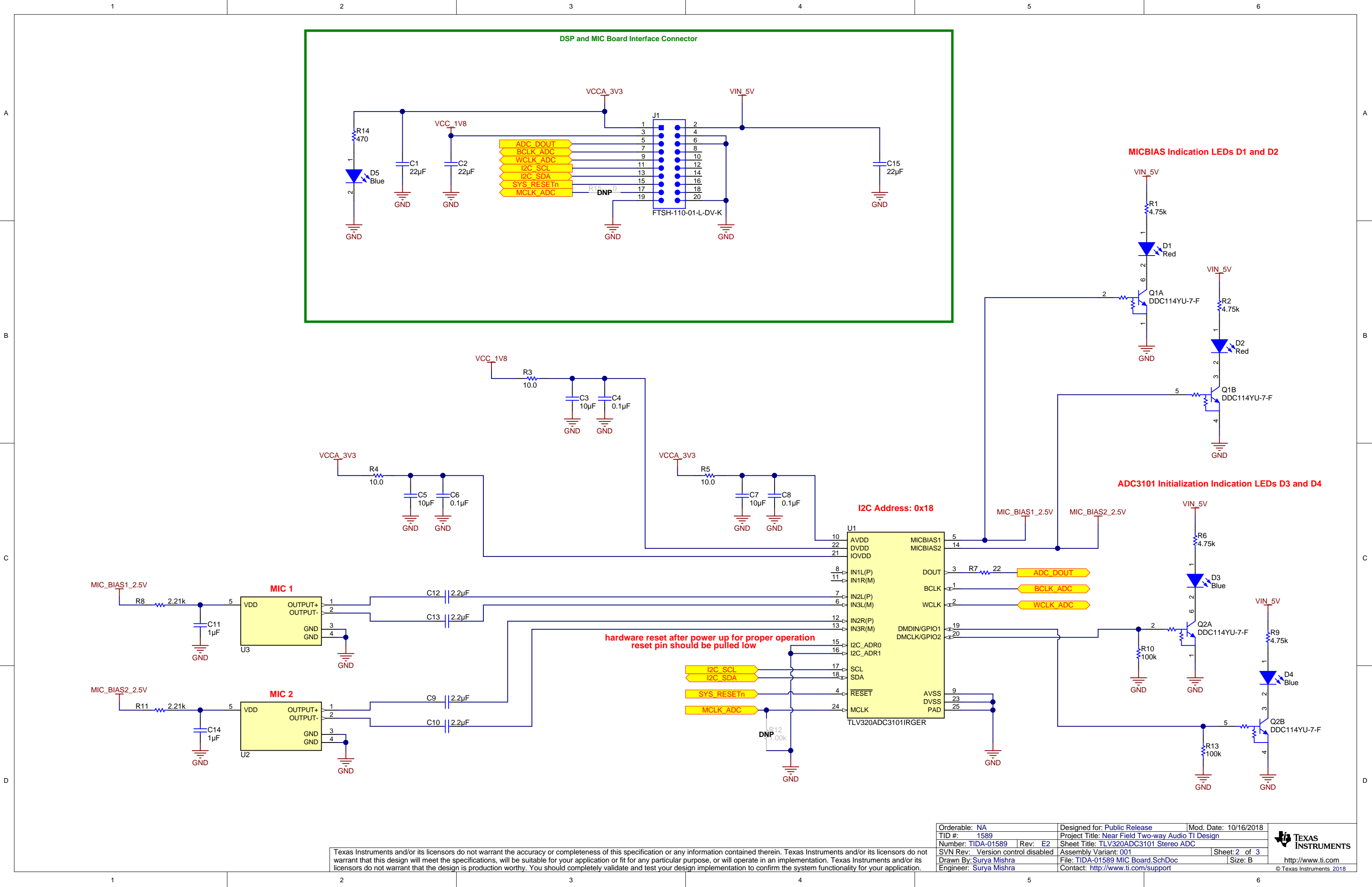


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Orderable: NA	Designed for: Public Release	Mod. Date: 10/16/2018
TID #: 1589	Project Title: Near Field Two-way Audio TI Design	
Number: TIDA-01589	Rev: E2	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Surya Mishra	File: TIDA-01589 Block Diagram.SchDoc	Size: B
Engineer: Surya Mishra	Contact: http://www.ti.com/support	

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Orderable: NA	Designed for: Public Release	Mod. Date: 10/16/2018
TID #: 1589	Project Title: Near Field Two-way Audio TI Design	
Number: TIDA-01589	Rev: E2	Sheet Title: TLV320ADC3101 Stereo ADC
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Surya Mishra	File: TIDA-01589 MIC Board.SchDoc	Size: B
Engineer: Surya Mishra	Contact: http://www.ti.com/support	

PCB Number: TIDA-01589
PCB Rev: E2

Logo1
PCB
LOGO
WEEE logo

PCB
LOGO
FCC disclaimer

PCB
LOGO
Logo4

You should delete the nylon screws/standoffs and/or the bumpouts as needed for your design (or substitute other parts from Hardware.IntLib). Bumpouts are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You should delete this note too.

LBL1

PCB Label

THT-14-423-10
Size: 0.65" x 0.20 "

ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

Orderable: NA	Designed for: Public Release	Mod. Date: 10/16/2018		
TID #: 1589	Project Title: Near Field Two-way Audio TI Design			
Number: TIDA-01589	Rev: E2	Sheet Title:		
SVN Rev: Version control disabled		Assembly Variant: 001		Sheet: 3 of 3
Drawn By: Surya Mishra	File: TIDA-01589 EVM Hardware.SchDoc	Size: B		http://www.ti.com
Engineer: Surya Mishra	Contact: http://www.ti.com/support		© Texas Instruments 2018	

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